


Built on PMP9649Rev A Board

PCB Number: PMP10319
PCB Rev: A

PCB
LOGO
Texas Instruments

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| Designed for: Public Release | Mod. Date: 7/16/2014 |  http://www.ti.com © Texas Instruments 2014 |
| Project Title: UCC28710 High-side Buck Converter | Sheet Title: 85Vac-265Vac to 15V/0.4A | |
| Number: PMP10319 | Rev: A | Sheet: 1 of 2 |
| SVN Rev: Not in version control | Assembly Variant: 001 | Size: B |
| Drawn By: S Yu | File: PMP10319_01.SchDoc | Contact: http://www.ti.com/support |
| Engineer: Enter name of project lead | Contact: http://www.ti.com/support | |

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